

SCOPE FOR FUTURE WORK

- ❖ Other thermodynamic properties like viscosity, surface tension, etc. can be obtained using suitable methods.
- ❖ Electrochemical corrosion studies of the binary and ternary systems can be done.
- ❖ Mechanical behavior can also be studied.
- ❖ Electrical properties can be studied.
- ❖ Oxidation behavior can be studied at low temperature.

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